

Combat-Ready, 13" Fully-Rugged Notebook

R13S, the ultra-rugged notebook is designed for users work in the most extreme environments. With MIL-810G and IP65 certification, it can operate under the most vigorous condition; from searching desert to freezing terrains and from stealth mission to the heart of combat zone. It also packs Intel® 6th Generation Skylake-U CPU to run the most demanding tasks. With TPM, quick HDD release function and fingerprint scanner, R13S offers the undisputed security for data protection.

# **EXTREMELY RUGGED FEATURES**

R13S is IP65 and MIL-STD 810G certified. It is built with high quality of magnesium alloy that guarantees to perform. It can work at 15,000 feet in the air, extremely temperature of -30°C to +60°C, under the 40 G shock or 26 drops from 6 feet.

# **Secured Dual Battery Lock**

The lock prevents the battery from disengaging during vigorous vibration to ensure without interruption at any critical task.

# LONG BATTERY LIFE

## Fast charge

R13S can quick-charge its High-Capacity, 9-cell Smart Battery Pack for up to 90% of the capacity within merely 3 hours.

## **Hot Swap**

Equipped with quick release and hot swappable function, the second battery can further extends the battery life from 11 hours to 16 hours.



## STEALTH MODE

DURABOOK's unique Stealth Mode can be applied in special mission such as stakeout operation and raids. One click immediately turns off all sounds and emitting lights while all programs remain running in the background.

## **EXCEPTIONAL OUTDOOR DISPLAY**

Equipped with a 13.3" TFT LCD (1024 x 768) screen at 1050 nits with sunlight readable resistive touch panel, R13S offers excellent screen viewing even under direct sunlight.

# SUPERIOR SECURITY

To protect against unauthorized access to protected data, R13S is equipped with various devices of secured tools.

- ▼ Trusted Platform Module (TPM) chip
- Biometric Fingerprint Scanner
- Quick Release HDD: It allows for less than 5-second ejection of disk drive in a situation when protecting valuable data.

LETTRONICA SpA

## **Specifications**

#### **EXTREME Gunfire Shock** Operating System Genuine Windows 10 Professional<sup>1</sup> **Environment** MIL-STD 810G Method 519.6, Annex D, Table 519.6D-I CPU ■ Intel® 6th Generation skylake-U Hazardous Shoc MIL-STD 810G Method 516.6 Procedure V, 75G's ■ 13.3" XGA(1024x768) TFT LCD Display @8ms, 3 shocks/axis/direction, total 18 shocks Single resistive Touch Panel Helicopter Integrity Sunlight Readable 1050 nits Display MIL-STD 810G, Method 514.6, Procedure I, Category ■ Two DDRIIII sockets (Max. 32GB) 24, Fig. 514.6E-2 Memory **Blowing Rain** Storage ■ 2.5" SATA HDD or SSD MIL-STD 810G, Method 506.5, Procedure II, 30 Minutes, 70MPH Optical Disk Drive DVD Super Multi **Blowing Dust** MIL-STD 810G, Method 510.5 Procedure I, Air Flow Keyboard Illuminated keyboard with adjustable brightness 1725 FPM, (23°C~60°C for 12 hours) Audio ■ Intel<sup>®</sup> High Definition Audio **Explosive Atmosphere** MIL-STD 810G Method 511.5, Procedure I ■ 1.5KHz Speaker x 2 / 75dB Analog Microphone Freeze Thaw MIL-STD 810G, Method 524, Procedure III Two 10/100/1000 Mbps Ethernet Communication Acidic Atmosphere Intel® Dual Band Wireless AC8260 (a/b/g/n/AC) & MIL-STD 810G, Method 518.1 Bluetooth 4.2 Solar Radiation MIL-STD 810G, Method 505.5, Procedure II LTE WWAN<sup>1</sup> ■ GPS<sup>1</sup> (UBLOX-NEO-M8N) MIL-STD 810G, Method 509.5 Security Smart Card Reader<sup>1</sup> Computrace® Ready MIL-STD 461F Level II ■ Intel<sup>®</sup>vPro ■ TPM 2.0 **IP65** IPx5 IEC 529 (EN6052) Kensington Lock IP6X IEC 529 (EN60529) Stealth Mode Fingerprint Scanner **Rugged Features** Quick Release HDD MIL-STD 810G 516.6 Procedure IV, 26 drops from 6 feet height onto plywood over concrete Button Power Vibration General Integrit RF ON / OFF MIL-STD 810G, Method 514.6, Procedure I, Category Programmable button x1 24, Fig. 514.6E-2 **Expansion Slots** One Smart Card Reader Vibration Truck Transport One Express Card 54 or PCMCIA ASTM 4169, 11.5.2 Random test, Assurance Level II **Functional Shock** I/O Ports ■ Two USB2.0 MIL-STD 810G Method 516.6 Procedure I40G's @11ms, One USB3.0 3 shocks/axis/direction 18 total shocks One headphone jack Rain Test One microphone jack MIL-STD 810G, Method 506.4, Procedure II, 40 PSIG, Two RJ-45 min 6 axis, 4 in/hour One VGA port or HDMI or Second RS232 Temperature Sho One RS232 port MIL-STD810G, Method 503.5, Procedure I-C,3 cycles One Docking connector Three RF pass through for WLAN and GPS and WWAN Environment Temperature Operating: -30°C ~ 60°C<sup>2</sup> MIL-STD 810G 501.5 Procedure II **Battery** Primary 9-Cells 7800 mAh battery pack: 11 hrs<sup>3</sup> Storage: -51°C ~ 71°C MIL-STD 810G 501.5/502.5 6-Cells 3800mAh battery pack<sup>1'4</sup> 5 hrs<sup>3</sup> Procedure I **AC Adaptor** Humidity ■ 100V - 240V; 90W Operating: 5% ~ 95% **Dimension** ■ 306 mm (W) x 294 mm (D) x 58 ~ 65 mm (H) Altitude Operating: 15,000 feet MIL-STD 810G 500.5 Procedure II Weiaht 3.6 Kg / 7.9 lbs<sup>5</sup> Non Operating: 40,000 feet MIL-STD 810G 500.5 Procedure I

## Accessories











Car Adaptor

- 1. Optional items
- 2. With extended temperature SSD or HDD heater
- 3. Mobile Mark Life Test Method (Battery life may vary with product configurations, settings, usage patterns and operating environment.)
- 4. 6 cell battery pack is mutually exclusive with Optical Disk Drive
- 5. Actual weight may vary with different configurations





